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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10058854	01/28/2002	257	375	2820 2011	23 DEC 2002 RPT...

**APPLICANTS: Hellig Kay; Bonser Douglas; Qi 'Ven-Jie;

**CONTINUING DATA VERIFIED:
THIS APPLN CLAIMS BENEFIT OF 60/340,554 12/14/2001

** FOREIGN APPLICATIONS VERIFIED:

NONE 9/15

PG-PUB	DO NOT PUBLISH <input checked="" type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	ATTORNEY DOCKET NO	
35 USC 119 conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	1458.TT47962	
Verified and Acknowledged Examiner's initials <i>MM</i>			
TITLE : System for forming a semiconductor device and method thereof			

U.S. DEPT. OF COMM./PAT. & TM-PTO-43BL (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G
ISSUE FEE		Primary Examiner	DRAWING	
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner		
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